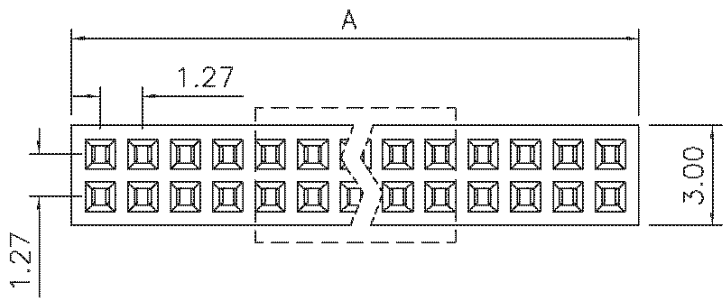
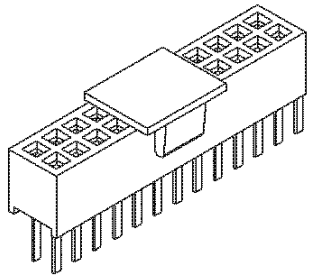
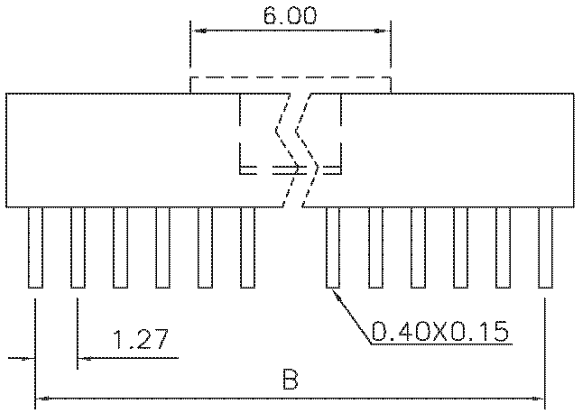
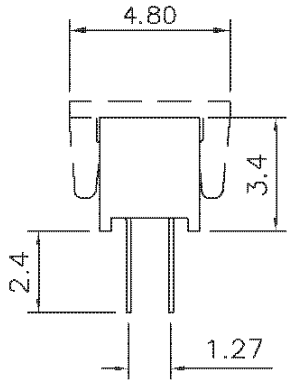
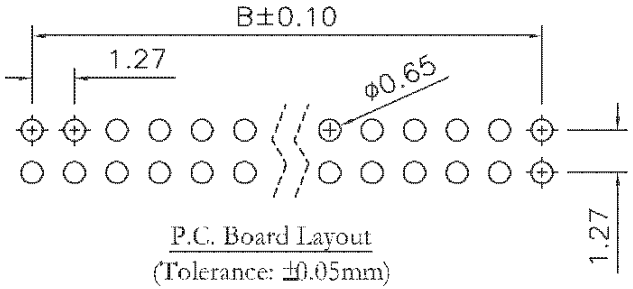
REV.	SPECIFICATION	ECN NO.	APPD.
R1			











P.C. Board Layout
(Tolerance: ±0.05mm)

Material:

Housing: High Temperature Plastic UL94V-0, withstands IR and VPR soldering methods.
Contacts: Phosphor Bronze.

Electrical Characteristics:

Current Rating: 1 AMP.
Dielectric Withstanding Voltage: AC 500V for 1 minute.
Insulator Resistance: 1000MΩ min. at DC 500V.
Contact Resistance: 20mΩ max. at DC 100mA.
Operating Temperature: -65°C~+125°C.
Max Processing Temperature: 230°C for 30~60 seconds.

***RoHS Compliant**

Insertion Depth: 2.00mm to 3.00mm

2241- 2 X xx C xx S U -P

- Series
- Double Row
- No.of Pin Per Row
- C: Selective Gold Plated
- G: Gold Plated
- 00: G/F
- 10: 10μ"
- 15: 15μ"
- 30: 30μ"
- S: Straight
- T: Tube & Reel Package
- U: Tube Package
- Blank: W/O Pad
- P: Plastic Pad
- M: Metal Pad

Position	6 Thru 100
Dimension	
A	1.27 X No. of Positions/2+0.46
B	1.27 X No. of Positions/2-1.27

Tolerances	Drawn No.	2241D02001	Title: 2241 Series P.C.B. Socket 1.27mmX1.27mm	Mega-Chip Electronics Pte Ltd.	
x = ±0.5	Projection			P/N:	2241-2XxxCxxSU-P
.x = ±0.25	Unit mm	Scale 1:1		SHEET 1/1	Ver.No. R1
.xx = ±0.15	Drawn By	Liling 02/17'09			